EMD22 / UMD22N

General purpose (dual digital transistor)

SOT-363

UMD22N

(UMT6)

DTr2

(3)

(2)

Parameter	Value	
V _{CC}	50V	
I _{C(MAX.)}	100mA	
R ₁	4.7kΩ	
R ₂	47kΩ	

<For DTr2(PNP)>

Parameter	Value	
V _{CC}	-50V	
I _{C(MAX.)}	-100mA	
R ₁	4.7kΩ	
R ₂	47kΩ	

Features

- 1)Both the DTA143Z chip and DTC143Z chip in a EMT or UMT package.
- 2)Mounting possible with EMT3 or UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMD22	SOT-563 (EMT6)	1616	T2R	180	8	8000	D22
UMD22N	SOT-363 (UMT6)	2021	TR	180	8	3000	D22

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•Outline

EMD22

(EMT6)

Inner circuit

(1) DTr1 GND(Emitter)

(3) DTr2 OUT(Collector)

(4) DTr2 GND(Emitter)

(6) DTr1 OUT(Collector)

DTr1

(1)

(2) DTr1 IN(Base)

(5) DTr2 IN(Base)

EMD22 / UMD22N

• Absolute maximum ratings (T_a = 25°C)

Parameter			DTr1(NPN)	DTr2(PNP)	Unit
Supply voltage	V _{CC}	50	-50	V	
Input voltage	V _{IN}	-5 to 30	-30 to 5	V	
Output current	Ι _Ο	100	-100	mA	
Collector current			100	-100	mA
Power dissipation EMD22/ UMD22N			1:	50	mW/Total
Junction temperature			150		°C
Range of storage temperature			-55 to	+150	°C

•Electrical characteristics (T_a = 25°C) <For DTr1(NPN)>

Parameter	Sumbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input veltage	V _{I(off)}	V _{CC} = 5V, I _O = 100µA	-	-	0.5	V	
Input voltage	V _{I(on)}	V _O = 0.3V, I _O = 5mA	1.3	-	-		
Output voltage	Output voltage $V_{O(on)}$ $I_O = 5mA$, $I_I = 250\mu A$		-	100	300	mV	
Input current	I _I	V ₁ = 5V	-	-	1.8	mA	
Output current	I _{O(off)}	V _{CC} = 50V, V _I = 0V	-	-	500	nA	
DC current gain	G _I	V _O = 5V, I _O = 10mA	80	-	-	-	
Input resistance	R ₁	-	3.29	4.7	6.11	kΩ	
Resistance ratio	R_2/R_1	-	8	10	12	-	
Transition frequency	f _T *1	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

•Electrical characteristics (T_a = 25°C) <For DTr2(PNP)>

Deremeter	Sumbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Innutveltage	V _{I(off)}	V _{CC} = -5V, I _O = -100µA	-	-	-0.5	V	
Input voltage	V _{I(on)}	V _O = -0.3V, I _O = -5mA	-1.3	-	-	V	
Output voltage	V _{O(on)}	I _O = -5mA, I _I = -250µA	-	-100	-300	mV	
Input current	I _I	V _I = -5V	-	-	-1.8	mA	
Output current DC current gain Input resistance	I _{O(off)}	V _{CC} = -50V, V _I = 0V	-	-	-500	nA	
	G _I	V _O = -5V, I _O = -10mA	80	-	-	-	
	R ₁	-	3.29	4.7	6.11	kΩ	
Resistance ratio	R ₂ /R ₁	-	8	10	12	-	
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz	

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference land.

*3 120mW per element must not be exceeded.

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•Electrical characteristic curves(T_a = 25°C) <For DTR1(NPN)>

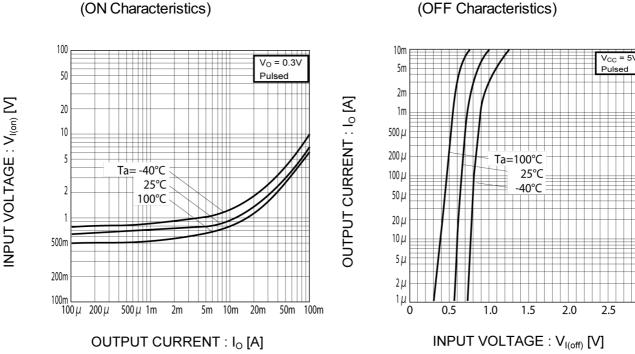


Fig.1 Input Voltage vs. Output Current (ON Characteristics)

Fig.3 Output Current vs. Output Voltage



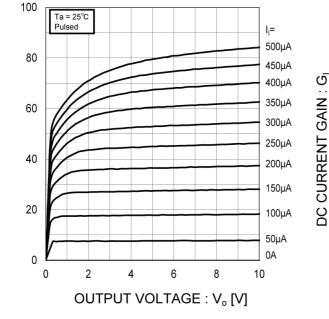
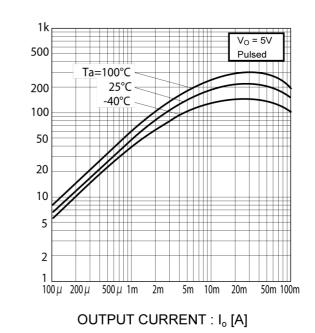


Fig.4 DC Current Gain vs. Output Current

Fig.2 Output Current vs. Input Voltage





•Electrical characteristic curves(T_a = 25°C) <For DTR1(NPN)>

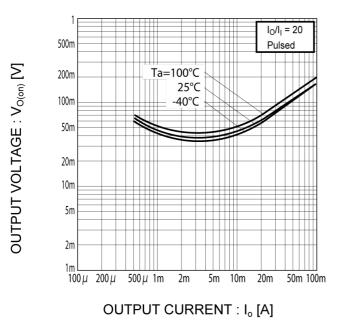


Fig.5 Output Voltage vs. Output Current



Electrical characteristic curves(T_a=25°C) <For DTr2(PNP)>

Fig.1 Input Voltage vs. Output Current

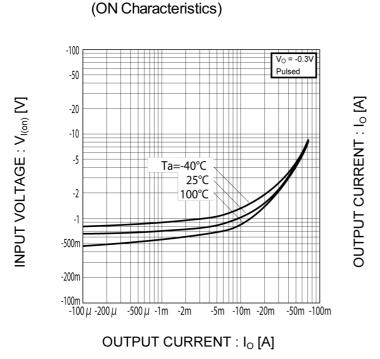


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

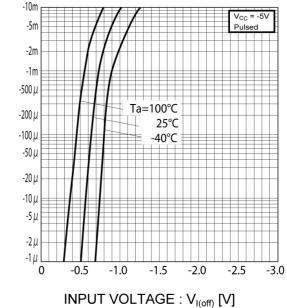


Fig.3 Output Current vs. Output Voltage

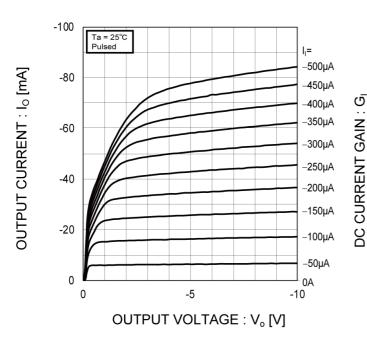
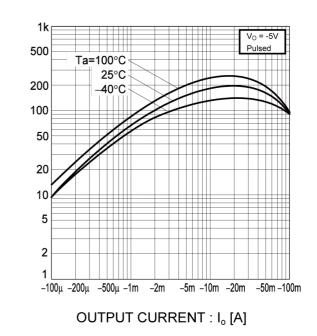


Fig.4 DC Current Gain vs. Output Current



•Electrical characteristic curves(T_a=25°C) <For DTr2(PNP)>

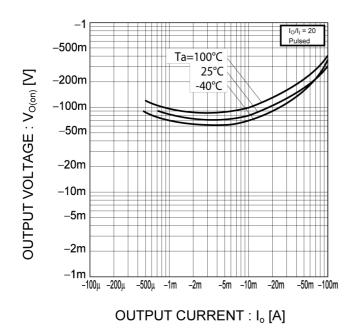
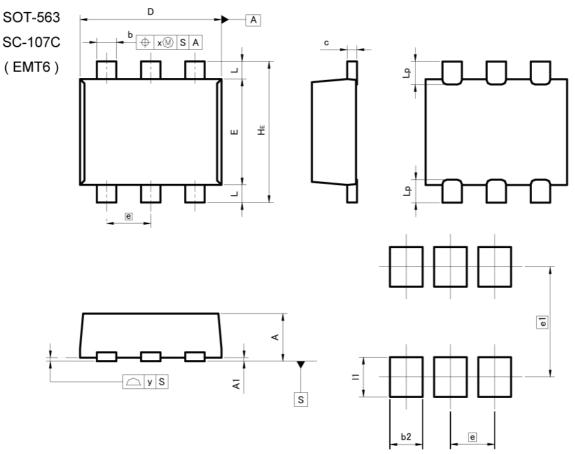


Fig.5 Output Voltage vs. Output Current



Dimensions



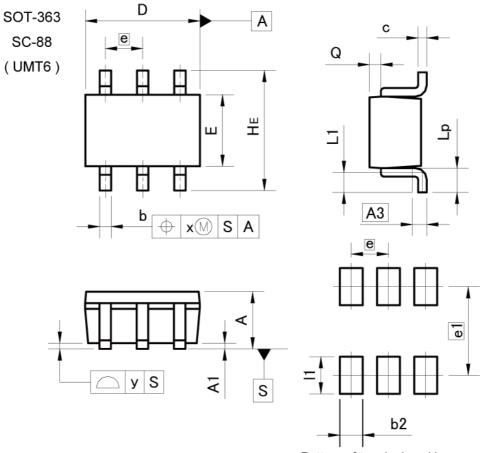
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
с	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.0	20	
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	-	0.35	-	0.014	
x	-	0.10	-	0.004	
У	-	0.10	-	0.004	
DIM	MILIMET		INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
e1	1.	25	0.049		
11	-	0.45	-	0.018	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

MIN MAX MIN MAX A 0.80 1.00 0.031 0.039 A1 0.00 0.10 0.000 0.004 A3 0.25 0.010 0.006 0.012 c 0.15 0.30 0.006 0.012 c 0.10 0.20 0.004 0.008 D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004	DIM	MILIN	IETERS	INCHES		
A1 0.00 0.10 0.000 0.004 A3 0.25 0.010 0.006 0.012 b 0.15 0.30 0.006 0.012 c 0.10 0.20 0.004 0.008 D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 y - 0.10 - 0.004	DIM	MIN	MAX	MIN	MAX	
A3 0.25 0.010 b 0.15 0.30 0.006 0.012 c 0.10 0.20 0.004 0.008 D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004	А	0.80	1.00	0.031	0.039	
b 0.15 0.30 0.006 0.012 c 0.10 0.20 0.004 0.008 D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004	A1	0.00	0.10	0.000	0.004	
c 0.10 0.20 0.004 0.008 D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES INCHES	A3	0	.25	0.0	10	
D 1.90 2.10 0.075 0.083 E 1.15 1.35 0.045 0.053 e 0.65 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES	b	0.15	0.30	0.006	0.012	
E 1.15 1.35 0.045 0.053 e 0.65 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 MILIMETERS INCHES INCHES	С	0.10	0.20	0.004	0.008	
e 0.65 0.026 HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES INCHES	D	1.90	2.10	0.075	0.083	
HE 2.00 2.20 0.079 0.087 L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES INCHES	E	1.15	1.35	0.045	0.053	
L1 0.20 0.50 0.008 0.020 Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES INCHES	е	0	.65	0.026		
Lp 0.25 0.55 0.010 0.022 Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 MILIMETERS INCHES INCHES	HE	2.00	2.20	0.079	0.087	
Q 0.10 0.30 0.004 0.012 x - 0.10 - 0.004 y - 0.10 - 0.004 MILIMETERS INCHES INCHES	L1	0.20	0.50	0.008	0.020	
x - 0.10 - 0.004 y - 0.10 - 0.004 DIM MILIMETERS INCHES	Lp	0.25	0.55	0.010	0.022	
y - 0.10 - 0.004 DIM MILIMETERS INCHES	Q	0.10	0.30	0.004	0.012	
DIM MILIMETERS INCHES	х	-	0.10	-	0.004	
	У	-	0.10	-	0.004	
DIM						
MIN MAX MIN MAX	DIM	MILIN	IETERS	INC	HES	
	DIM	MIN	MAX	MIN	MAX	

L	DIM	IVILLIVIL I LK3		INC	IILS
	DIN	MIN	MAX	MIN	MAX
	b2	- 1	0.40	-	0.016
	e1	1.	55	0.0	61
	11	—	0.65	-	0.026

Dimension in mm/inches



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

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